

Docket No.: 49677-091

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Response Under 37 CFR 1.116 - Expedited Procedure
 : Customer Number: 20277
 :
 Shinichi YAMAGATA, et al. : Confirmation Number: 5385
 :
 Serial No.: 09/925,427 : Group Art Unit: 1742
 :
 Filed: August 10, 2001 : Examiner: Jenkins, Daniel J.
 :

For: SUBSTRATE MATERIAL FOR MOUNTING A SEMICONDUCTOR DEVICE, SUBSTRATE FOR
 MOUNTING A SEMICONDUCTOR DEVICE, SEMICONDUCTOR DEVICE, AND METHOD OF
 PRODUCING THE SAME.

Mail Stop AF
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.



No additional fee is required.

Applicant is entitled to small entity status under 37 CFR 1.27.

Also attached: Petition for Extension of Time

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	9	20	0	\$18.00	\$0.00
Independent Claims	1	3	0	\$86.00	\$0.00
Multiple claims newly presented					\$0.00
Fee for extension of time					\$110.00
					\$0.00
Total of Above Calculations					\$110.00

- ☒ Please charge my Deposit Account No. 500417 in the amount of \$110.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

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Certification of Facsimile Transmission

I hereby certify that this paper is being facsimile transmitted to the Patent and Trademark Office on the date shown below.

David M. Tennant
 Type or print name of person signing certification
David M. Tennant 4-16-04
 Signature Date